



# THE UNITED STATES PATENT AND TRADEMARK OFFICE (Attorney Docket No. 100214)

Applicant(s): Abaneshwar PRASAD

Serial No.:

10/807,064

Filing Date:

3/23/2004

For:

CMP POROUS PAD WITH

**COMPONENT-FILLED PORES** 

**CERTIFICATE OF MAILING** 

I, MARIEJOSE MONSALVE, HEREBY CERTIFY THAT THIS CORRESPONDENCE AND ENCLOSURE(S), IF ANY, ARE HEREBY BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE IN AN ENVELOPE WITH SUFFICIENT POSTAGE FOR FIRST CLASS MAIL DELIVERY TO THE USPTO AT THE MAIL STOP/ADDRESS INDICATED BELOW ON 2750000.

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## SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA, 22313-1450

Pursuant to 37 CFR 1.97 and 1.98, the references listed on the enclosed Form PTO/SB/08A are submitted for consideration by the Examiner in the examination of the above-identified patent application.

The cited document(s) disclose(s) numerous specific features. There has been no attempt to enumerate each and every feature disclosed by each document, however. The Examiner is requested to review the(se) document(s) and to determine the extent of the materiality of the document disclosure(s), if any, with respect to the present invention.

No inference should be drawn that the attached list represents a comprehensive investigation, or that any disclosure in the listed documents is equivalent to the subject invention. The discussion of any art and the citation of any document(s) herein is not to be construed as an admission that the art or document disclosure(s) is/are necessarily within the invention field of endeavor or is/are necessarily prior in time to a particular date which may be relevant with respect to the instant application. Further, the recitation herein of the art and document(s) is not to be construed as an assertion that more pertinent art could not possibly be in existence, or that the newly cited document(s) is/are necessarily prior art as defined by the patent law.

Applicant(s) reserve(s) the right to later set forth how the claimed invention is distinguished over the disclosure of any document or other art, including the disclosure(s) of the art and document(s) recited herein, and that may be cited by the Examiner in rejecting a claim in the instant patent application.

Cabot Microelectronics Corporation 870 North Commons Drive Aurora, Illinois, 60504 (630) 375-5465

| The Information Disclosure Statement is being filed | The Int | formation | Disclo | sure State | ement is | being | filed | l: |
|---|---------|-----------|--------|------------|----------|-------|-------|----|
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| within any one of the following time periods: (a) within three months of the filing date of a   |
|---|
| national application other than a continued prosecution application under 37 CFR 1.53(d);       |
| (b) within three months of the date of entry of the national stage as set forth in 37 CFR 1.491 |
| of an international application; (c) before the mailing date of a first Office Action on the    |
| merits; or (d) before the mailing of a first Office Action after the filing of a request for    |
| continued examination under 37 CFR 1.114.   |

- after (a), (b), (c) or (d) above, but before the mailing date of a final action under 37 CFR 1.113, a Notice of Allowance under 37 CFR 1.311, or an action that otherwise closes prosecution in the application, and includes *one* of:
  - the Statement under 37 CFR 1.97(e) (see "Statement under 37 CFR 1.97(e)" below). or
  - the fee of \$180 set forth in 37 CFR 1.17(p) (see "Fees" below).

## Copies of the References

Copies of all of the references listed on the enclosed Form PTO/SB/08A are enclosed herewith.

### Statement under 37 CFR 1.97(e)

The undersigned hereby states that each item of information contained in the Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign patent application not more than three months prior to the filing of the Information Disclosure Statement.

### Fees and Method of Payment

 $\boxtimes$  No fee is owed by the applicant(s).

Respectfully\_submitted,

Date: 27 JUL 2005

Steven Weseman (Reg. No. 41,372) Attorney for the Applicant(s)

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| Comparable to Form PTO/SBO8A                       | Complete if Known      |                   |  |
|--|------------------------|-------------------|--|
| AUG 0 1 2005 🗒                                     | Application Number:    | 10/807,064        |  |
|  | Filing Date:           | 3/23/2004         |  |
| INFORMATION DISCLOSURE STATEMENT BY APPLICANTEMENT | First Named Inventor:: | Abaneshwar PRASAD |  |
| BY APPLICATION                                     | Art Unit: `            | 1755              |  |
|  | Examiner Name:         |                   |  |
|  | Atty. Docket No.:      | 100214            |  |

|                          | U.S. PATENT DOCUMENTS |  |                      |   |   |
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| Examin<br>er<br>Initials | Cit<br>e<br>No.       | Document Number  Number-Kind  Code  (if known) | Publicat<br>ion Date | Name of Patentee or<br>Applicant of Cited<br>Document | Pages, Columns, Lines<br>Where Relevant Passages Or<br>Figures Appear |
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| Examin<br>er<br>Initials | Cit<br>e<br>No.          | Foreign Patent Document Country Code- Number-Kind Code (if known) | Publicat<br>ion Date | Name of Patentee or<br>Applicant of Cited<br>Document | Pages, Columns,<br>Lines Where<br>Relevant Passages<br>Or Figures Appear | Т |
|                          |                          |   |                      |   |  |   |

|                          |                 | OTHER DOCUMENTS (NON PATENT LITERATURE DOCUMENTS   |   |
|--------------------------|-----------------|--|---|
| Examin<br>er<br>Initials | Cit<br>e<br>No. | Author's NAME, title of the article, book, magazine, journal, serial, symposium, catalog, etc., date, page(s), volume-issue number(s), publisher, city and/or country of publication                   | T |
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|                          | B5              | Thimothy DYER, Jim SCHULTER: "Characterising CMP pad conditioning using diamond abrasives" Online, January 2002, XP002333235. URL: http://www.micromagazine.com/archive/02/01/dyer.html                |   |

| Examiner's Signature: | Date Considered: |  |  |  |  |
|-----------------------|------------------|--|--|--|--|
|                       |                  |  |  |  |  |